



Doosan Corporation  
Electro-Materials

# DS-7209 (P)

(ANSI : CEM-3) LOW CTE

COPPER CLAD LAMINATES

## Features

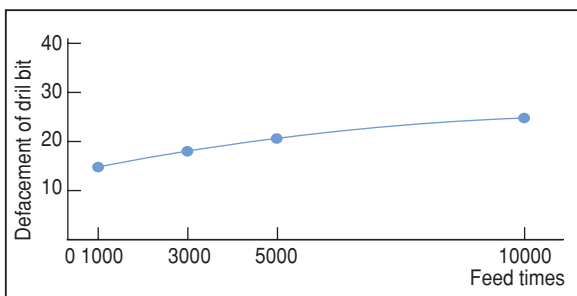
- Process similar to FR-4 including PTH
- Punching process applicable.
- Excellent mechanical & electrical properties
- Lower thermal expansion

## Applications

Test & Measurement equipment, Tuner, Car electronics, Power supply, etc.

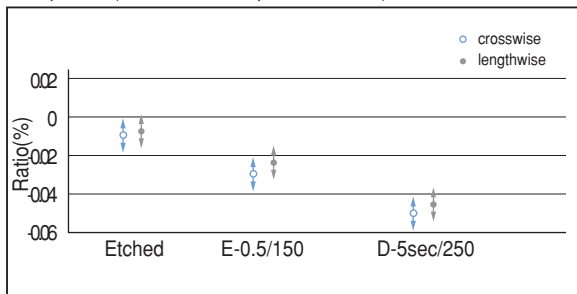
### Drilling processability

Drill defacement (Round direction) (60,000rpm, 50  $\mu$ m/ rev ,3 sheets)

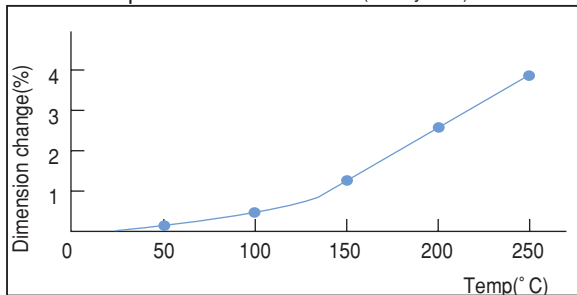


### Dimensional stability

PCB process (size360X310mm span310X254mm)



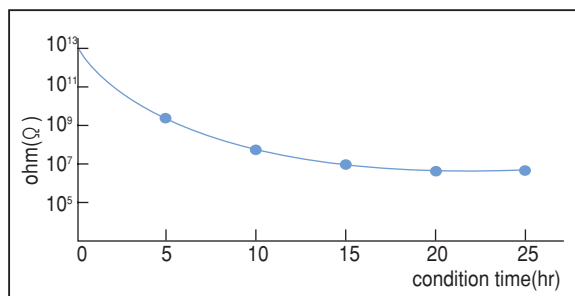
### Thermal expansion of Z-direction (Test by TMA)



## International Standard Recognition

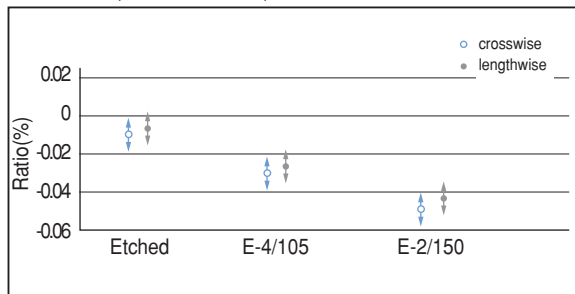
- UL : E103670
- CSA : LS-93237
- BSI : 6741
- VDE : VDE-Reg-Nr. 4945

### Insulation resistance at pressure cooker

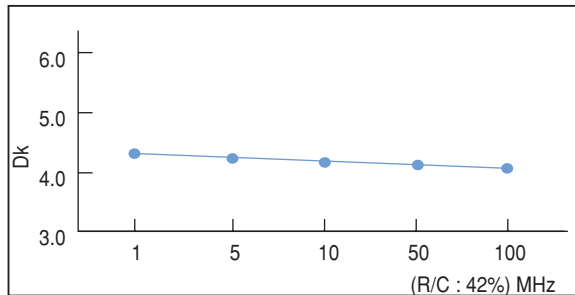


### Dimensional stability

Test method (IPC-TM-650 2.4.39)



### Dielectric constant



# COPPER CLAD LAMINATES

## General Properties

Test Item	Unit	Treatment Condition	Designation	DS-7209 (P)
			ANSI Grade	CEM-3
			Property Data	
			Standard Value	Guaranteed Value
Tg	°C	DSC	132	above 130
CTE x-axis y-axis z-axis	ppm/°C	Ambient to Tg	18 15 55	less than 20 less than 20 less than 60
Flammability	-	UL-94	V-0	V-0
Insulation Resistance	ohm	C-96/20/65+D-2/100	$1 \times 10^{10} - 1 \times 10^{11}$	above $1 \times 10^9$
Volume Resistivity	ohm	C-96/20/65 C-96/20/65+C-96/40/90	$1 \times 10^{14} - 1 \times 10^{15}$ $5 \times 10^{13} - 5 \times 10^{14}$	above $1 \times 10^{13}$ above $5 \times 10^{12}$
Surface Resistance	ohm-cm	C-96/20/65 C-96/20/65+C-96/40/90	$5 \times 10^{13} - 5 \times 10^{14}$ $1 \times 10^{12} - 1 \times 10^{13}$	above $1 \times 10^{12}$ above $1 \times 10^{11}$
Arc Resistance	min. sec		110	above 60
Dielectric Constant (1 MHz)	-	C-96/20/65 C-96/20/65+D-48/50	4.2 - 4.5 4.3 - 4.8	less than 5.5 less than 5.8
Dissipation Factor (1 MHz)	-	C-96/20/65 C-96/20/65+D-48/50	0.015 - 0.020 0.018 - 0.023	less than 0.035 less than 0.045
Comparative Tracking Index	volt	IEC Method	-	-
Solder Float (260°C)	sec	A	above 120	above 60
Peel Strength	Cu.foil oz (0.035mm) kgf/cm	A	1.6 - 1.8	above 1.43
Flexural Strength	kgf/mm <sup>2</sup>	A	25 - 46	above 22.4
Water Absorption	%	E-24/50+D-24/23	0.10 - 0.15	less than 0.25

Specimen Thickness : 1.6mm

## Purchasing Information

- Copper foil : 0.5 oz/ft<sup>2</sup>(0.018 mm), 1 oz/ft<sup>2</sup>(0.035 mm), 2 oz/ft<sup>2</sup>(0.070 mm) available
- Thickness : 1.6mm only

Standard Size	Tolerance(mm)
1,020 X 1,220mm (40" X 48")	+3
1,070 X 1,220mm (42" X 48")	-0
1,020 X 1,020mm (40" X 40")	

※ Other sheet size and thickness could be available upon request.